

# IRF8010PbF

## SMPS MOSFET

HEXFET® Power MOSFET

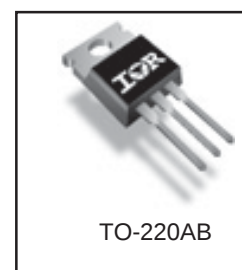
### Applications

- High frequency DC-DC converters
- UPS and Motor Control
- Lead-Free

| $V_{DSS}$ | $R_{DS(on)}$ max | $I_D$            |
|-----------|------------------|------------------|
| 100V      | 15m $\Omega$     | 80A <sup>⑥</sup> |

### Benefits

- Low Gate-to-Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective  $C_{OSS}$  to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current
- Typical  $R_{DS(on)} = 12m\Omega$



### Absolute Maximum Ratings

|                                   | Parameter                                | Max.            | Units               |
|-----------------------------------|------------------------------------------|-----------------|---------------------|
| $I_D$ @ $T_C = 25^\circ\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V | 80 <sup>⑥</sup> | A                   |
| $I_D$ @ $T_C = 100^\circ\text{C}$ | Continuous Drain Current, $V_{GS}$ @ 10V | 57              |                     |
| $I_{DM}$                          | Pulsed Drain Current <sup>①</sup>        | 320             |                     |
| $P_D$ @ $T_C = 25^\circ\text{C}$  | Power Dissipation                        | 260             | W                   |
|                                   | Linear Derating Factor                   | 1.8             | W/ $^\circ\text{C}$ |
| $V_{GS}$                          | Gate-to-Source Voltage                   | $\pm 20$        | V                   |
| $dv/dt$                           | Peak Diode Recovery $dv/dt$ <sup>③</sup> | 16              | V/ns                |
| $T_J$                             | Operating Junction and                   | -55 to + 175    | $^\circ\text{C}$    |
| $T_{STG}$                         | Storage Temperature Range                |                 |                     |
|                                   | Soldering Temperature, for 10 seconds    |                 |                     |
|                                   | Mounting torque, 6-32 or M3 screw        | 1.1(10)         | N•m (lb•in)         |

### Thermal Resistance

|                 | Parameter                           | Typ. | Max. | Units              |
|-----------------|-------------------------------------|------|------|--------------------|
| $R_{\theta JC}$ | Junction-to-Case                    | —    | 0.57 | $^\circ\text{C/W}$ |
| $R_{\theta CS}$ | Case-to-Sink, Flat, Greased Surface | 0.50 | —    |                    |
| $R_{\theta JA}$ | Junction-to-Ambient                 | —    | 62   |                    |

Notes <sup>①</sup> through <sup>⑥</sup> are on page 8

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Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                                 | Parameter                            | Min. | Typ. | Max. | Units      | Conditions                                            |
|---------------------------------|--------------------------------------|------|------|------|------------|-------------------------------------------------------|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | 100  | —    | —    | V          | $V_{GS} = 0V, I_D = 250\mu A$                         |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | 0.11 | —    | V/°C       | Reference to $25^\circ\text{C}, I_D = 1\text{mA}$     |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —    | 12   | 15   | m $\Omega$ | $V_{GS} = 10V, I_D = 45A$ ④                           |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | 2.0  | —    | 4.0  | V          | $V_{DS} = V_{GS}, I_D = 250\mu A$                     |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —    | —    | 20   | $\mu A$    | $V_{DS} = 100V, V_{GS} = 0V$                          |
|                                 |                                      | —    | —    | 250  |            | $V_{DS} = 100V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —    | —    | 200  | nA         | $V_{GS} = 20V$                                        |
|                                 | Gate-to-Source Reverse Leakage       | —    | —    | -200 |            | $V_{GS} = -20V$                                       |

Dynamic @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                        | Parameter                       | Min. | Typ. | Max. | Units | Conditions                                      |
|------------------------|---------------------------------|------|------|------|-------|-------------------------------------------------|
| gfs                    | Forward Transconductance        | 82   | —    | —    | V     | $V_{DS} = 25V, I_D = 45A$                       |
| $Q_g$                  | Total Gate Charge               | —    | 81   | 120  | nC    | $I_D = 80A$                                     |
| $Q_{gs}$               | Gate-to-Source Charge           | —    | 22   | —    |       | $V_{DS} = 80V$                                  |
| $Q_{gd}$               | Gate-to-Drain ("Miller") Charge | —    | 26   | —    |       | $V_{GS} = 10V$ ④                                |
| $t_{d(on)}$            | Turn-On Delay Time              | —    | 15   | —    | ns    | $V_{DD} = 50V$                                  |
| $t_r$                  | Rise Time                       | —    | 130  | —    |       | $I_D = 80A$                                     |
| $t_{d(off)}$           | Turn-Off Delay Time             | —    | 61   | —    |       | $R_G = 39\Omega$                                |
| $t_f$                  | Fall Time                       | —    | 120  | —    |       | $V_{GS} = 10V$ ④                                |
| $C_{iss}$              | Input Capacitance               | —    | 3830 | —    | pF    | $V_{GS} = 0V$                                   |
| $C_{oss}$              | Output Capacitance              | —    | 480  | —    |       | $V_{DS} = 25V$                                  |
| $C_{rss}$              | Reverse Transfer Capacitance    | —    | 59   | —    |       | $f = 1.0\text{MHz}$                             |
| $C_{oss}$              | Output Capacitance              | —    | 3830 | —    |       | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0\text{MHz}$ |
| $C_{oss}$              | Output Capacitance              | —    | 280  | —    |       | $V_{GS} = 0V, V_{DS} = 80V, f = 1.0\text{MHz}$  |
| $C_{oss \text{ eff.}}$ | Effective Output Capacitance    | —    | 530  | —    |       | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 80V$ ③    |

## Avalanche Characteristics

|          | Parameter                        | Typ. | Max. | Units |
|----------|----------------------------------|------|------|-------|
| $E_{AS}$ | Single Pulse Avalanche Energy ②⑥ | —    | 310  | mJ    |
| $I_{AR}$ | Avalanche Current ①              | —    | 45   | A     |
| $E_{AR}$ | Repetitive Avalanche Energy ①    | —    | 26   | mJ    |

## Diode Characteristics

|          | Parameter                                 | Min.                                                                 | Typ. | Max. | Units | Conditions                                                              |
|----------|-------------------------------------------|----------------------------------------------------------------------|------|------|-------|-------------------------------------------------------------------------|
| $I_S$    | Continuous Source Current<br>(Body Diode) | —                                                                    | —    | 80   | A     | MOSFET symbol<br>showing the<br>integral reverse<br>p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current<br>(Body Diode) ①⑥  | —                                                                    | —    | 320  |       |                                                                         |
| $V_{SD}$ | Diode Forward Voltage                     | —                                                                    | —    | 1.3  | V     | $T_J = 25^\circ\text{C}, I_S = 80A, V_{GS} = 0V$ ④                      |
| $t_{rr}$ | Reverse Recovery Time                     | —                                                                    | 99   | 150  | ns    | $T_J = 150^\circ\text{C}, I_F = 80A, V_{DD} = 50V$                      |
| $Q_{rr}$ | Reverse Recovery Charge                   | —                                                                    | 460  | 700  | nC    | $di/dt = 100A/\mu s$ ④                                                  |
| $t_{on}$ | Forward Turn-On Time                      | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) |      |      |       |                                                                         |

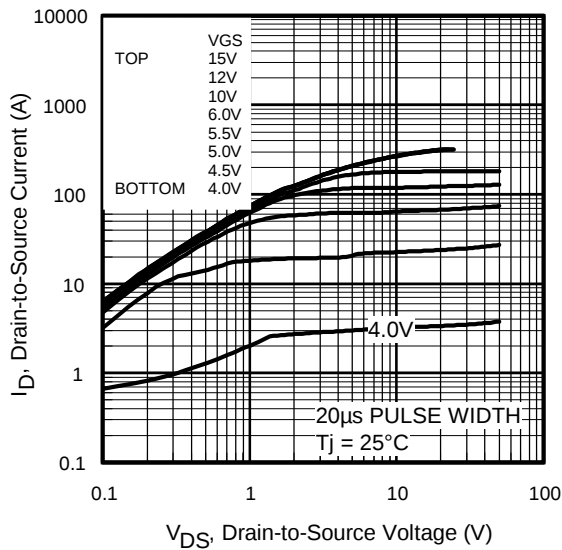


Fig 1. Typical Output Characteristics

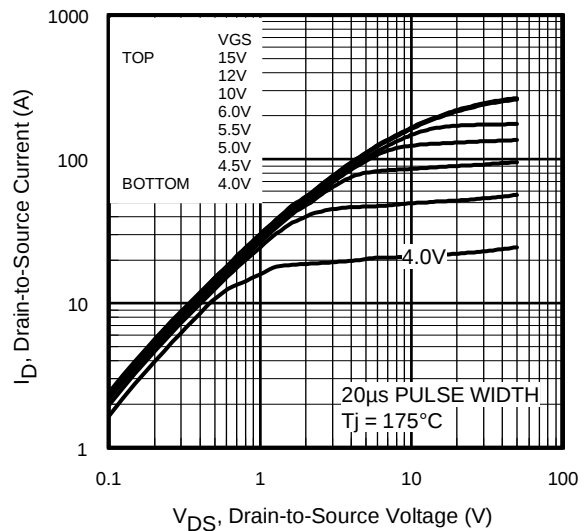


Fig 2. Typical Output Characteristics

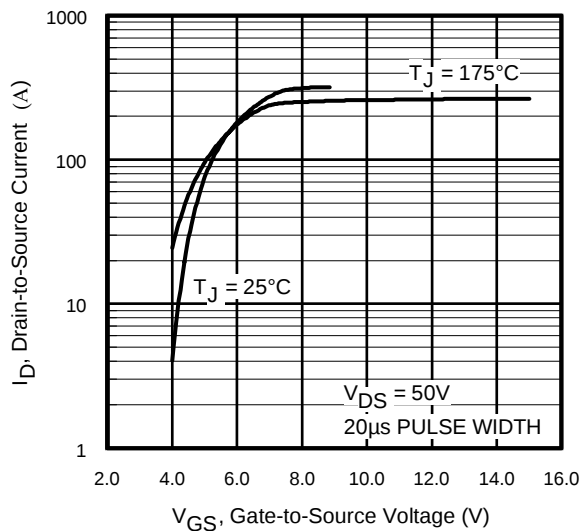


Fig 3. Typical Transfer Characteristics

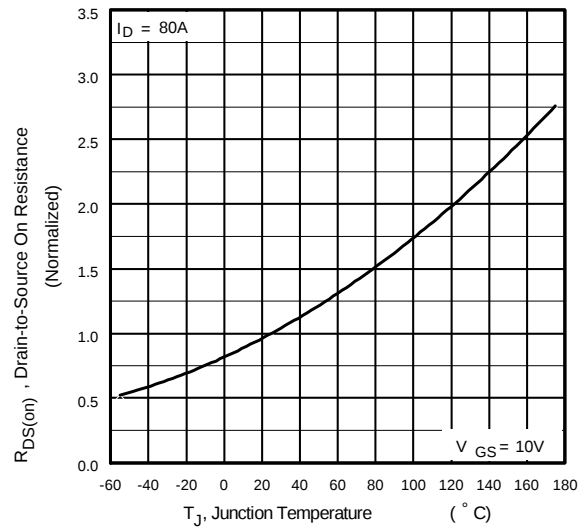
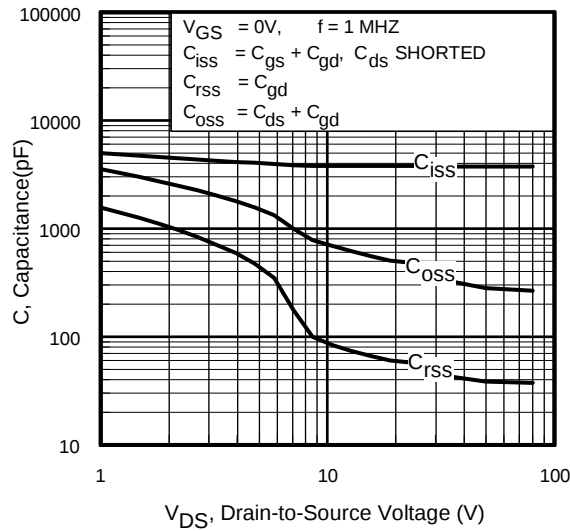


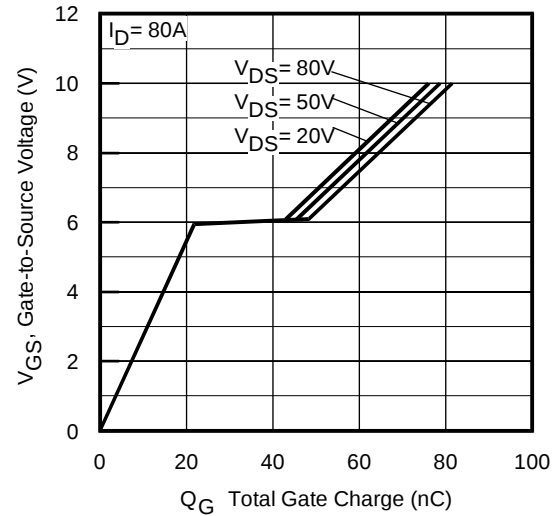
Fig 4. Normalized On-Resistance  
Vs. Temperature

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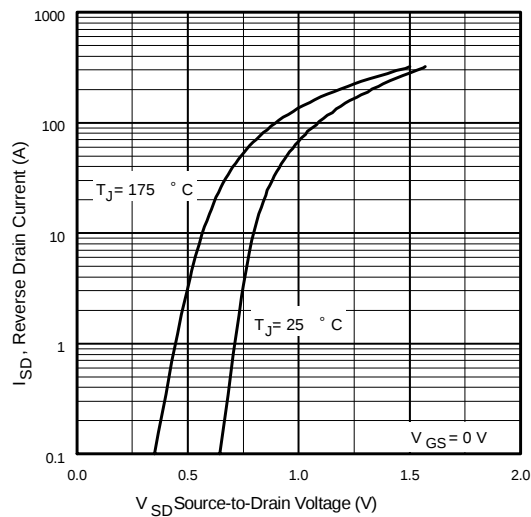
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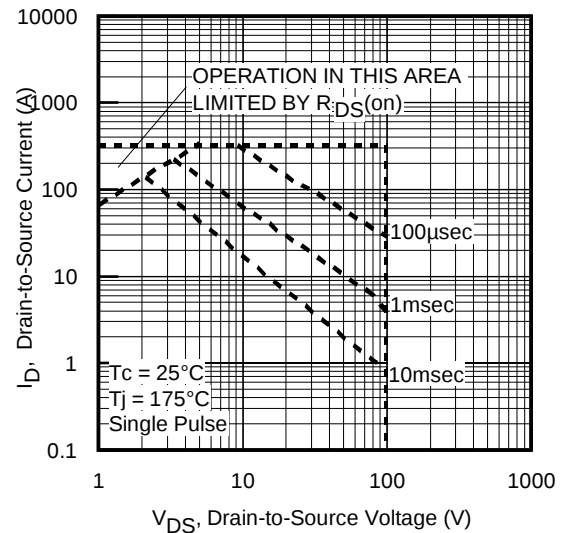
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



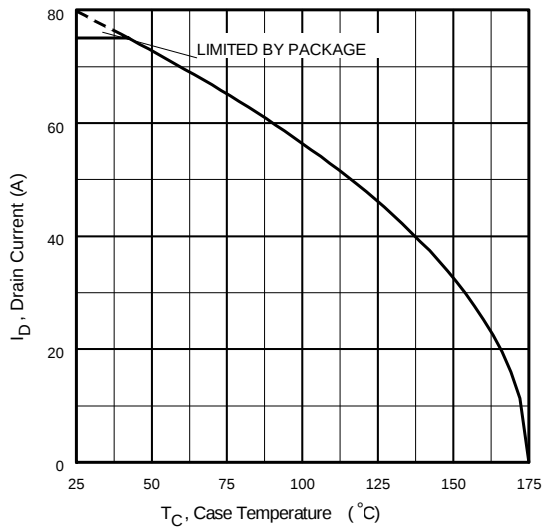
**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



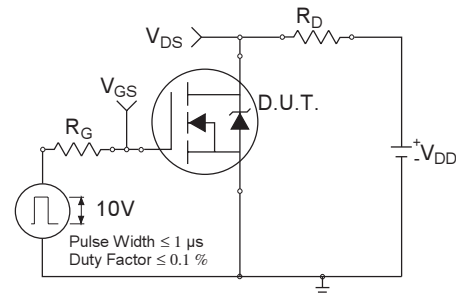
**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 8.** Maximum Safe Operating Area



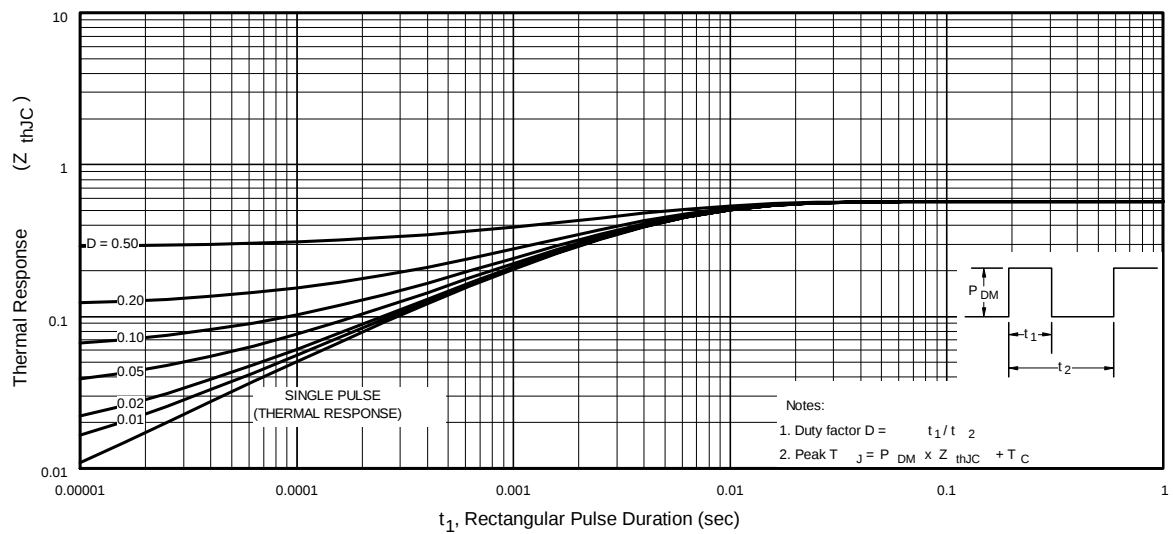
**Fig 9.** Maximum Drain Current Vs. Case Temperature



**Fig 10a.** Switching Time Test Circuit



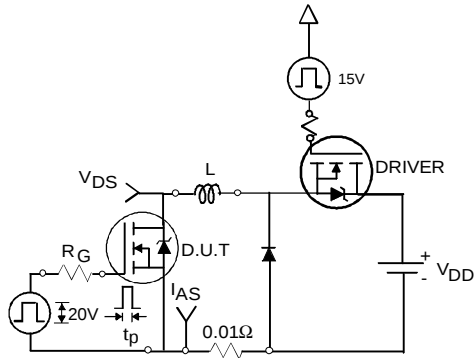
**Fig 10b.** Switching Time Waveforms



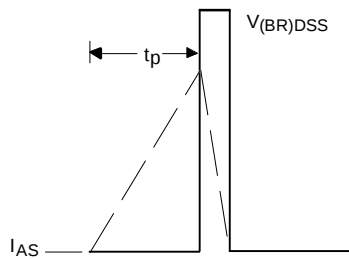
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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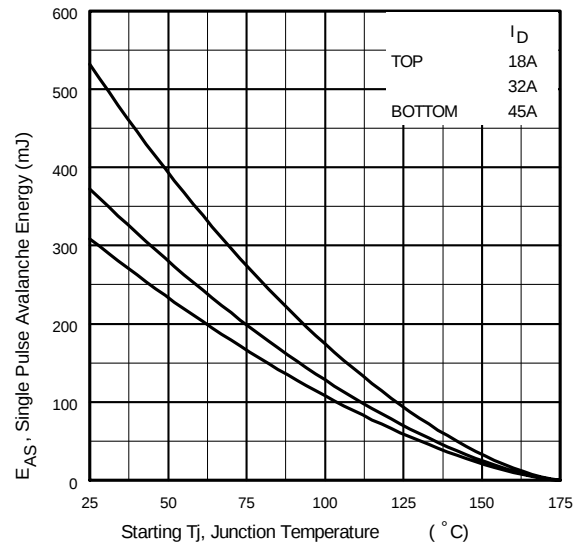
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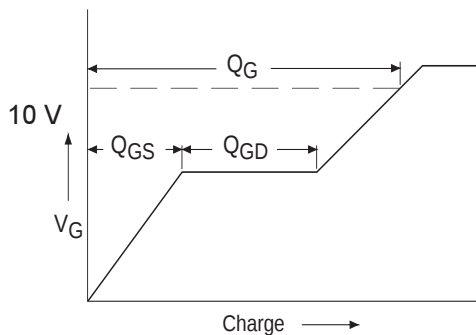
**Fig 12a.** Unclamped Inductive Test Circuit



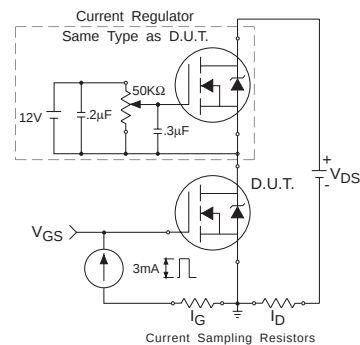
**Fig 12b.** Unclamped Inductive Waveforms



**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

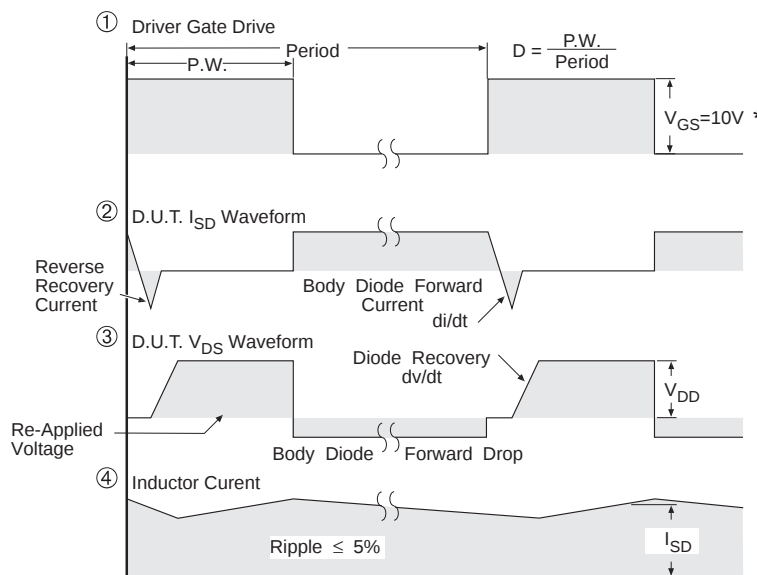


**Fig 13a.** Basic Gate Charge Waveform



**Fig 13b.** Gate Charge Test Circuit

### Peak Diode Recovery dv/dt Test Circuit



\*  $V_{GS} = 5V$  for Logic Level Devices

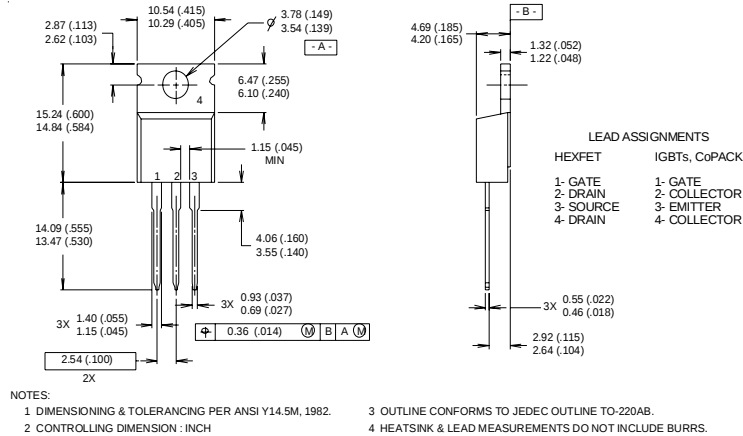
**Fig 14.** For N-Channel HEXFET® Power MOSFETs

# IRF8010PbF

## TO-220AB Package Outline

Dimensions are shown in millimeters (inches)

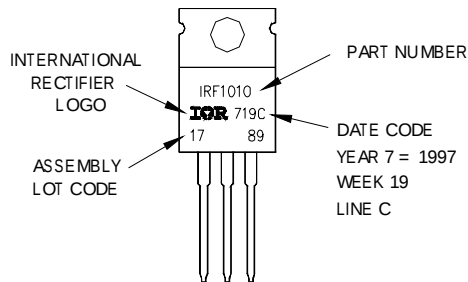
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## TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010  
LOT CODE 1789  
ASSEMBLED ON WW 19, 1997  
IN THE ASSEMBLY LINE "C"

**Note:** "P" in assembly line position indicates "Lead-Free"



### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.31\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 45\text{A}$ .
- ③  $I_{SD} \leq 45\text{A}$ ,  $di/dt \leq 110\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 175^\circ\text{C}$ .
- ④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ⑤  $C_{OSS}$  eff. is a fixed capacitance that gives the same charging time as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$ .
- ⑥ Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

**TO-220 package is not recommended for Surface Mount Application.**

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Industrial market.  
Qualification Standards can be found on IR's Web site.

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Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>

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